International IOR Rectifier

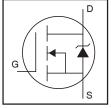
AUTOMOTIVE GRADE

AUIRFR3806

HEXFET® Power MOSFET

Features

- Advanced Process Technology
- Ultra Low On-Resistance
- Dynamic dV/dT Rating
- 175°C Operating Temperature
- Fast Switching
- Repetitive Avalanche Allowed up to Timax
- Lead-Free, RoHS Compliant
- Automotive Qualified *



V _{DSS}	60V
R _{DS(on)} typ.	12.6m $Ω$
max.	15.8m $Ω$
I _D	43A

Description

Specifically designed for Automotive applications, this HEXFET® Power MOSFET utilizes the latest processing techniques to achieve extremely low on-resistance per silicon area. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating. These features combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.



G	D	S
Gate	Drain	Source

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolutemaximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

Symbol	Parameter	Max.	Units
I _D @ T _C = 25°C	Continuous Drain Current, VGS @ 10V	43	
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10V	31	А
I _{DM}	Pulsed Drain Current ①	170	
P _D @T _C = 25°C	Maximum Power Dissipation	71	W
	Linear Derating Factor	0.47	W/°C
V_{GS}	Gate-to-Source Voltage	± 20	V
E _{AS}	Single Pulse Avalanche Energy (Thermally Limited) ②	73	mJ
I _{AR}	Avalanche Current ①	25	А
E _{AR}	Repetitive Avalanche Energy ④	7.1	mJ
dv/dt	Peak Diode Recovery ③	24	V/ns
T_J	Operating Junction and	-55 to + 175	°C
T _{STG}	Storage Temperature Range		
	Soldering Temperature, for 10 seconds (1.6mm from case)	300	

Thermal Resistance

Symbol	Parameter	Тур.	Max.	Units		
$R_{\theta JC}$	Junction-to-Case ®		2.12			
$R_{\theta CS}$	Case-to-Sink, Flat Greased Surface	0.50		°C/W		
$R_{\theta JA}$	Junction-to-Ambient ⑦		62			

HEXFET® is a registered trademark of International Rectifier.

^{*}Qualification standards can be found at http://www.irf.com/

Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	60			V	$V_{GS} = 0V, I_{D} = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.075		V/°C	Reference to 25°C, I _D = 5mA ^①
R _{DS(on)}	Static Drain-to-Source On-Resistance		12.6	15.8	mΩ	$V_{GS} = 10V, I_D = 25A \oplus$
$V_{GS(th)}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}$, $I_D = 50\mu A$
gfs	Forward Transconductance	41			S	$V_{DS} = 10V, I_{D} = 25A$
$R_{G(int)}$	Internal Gate Resistance		0.79		Ω	
I _{DSS}	Drain-to-Source Leakage Current			20	μΑ	$V_{DS} = 60V, V_{GS} = 0V$
				250		$V_{DS} = 48V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I_{GSS}	Gate-to-Source Forward Leakage			100	nΑ	$V_{GS} = 20V$
	Gate-to-Source Reverse Leakage			-100		$V_{GS} = -20V$

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
Q_g	Total Gate Charge		22	30	nC	I _D = 25A
Q_{gs}	Gate-to-Source Charge		5.0			$V_{DS} = 30V$
Q_{gd}	Gate-to-Drain ("Miller") Charge		6.3			V _{GS} = 10V ④
Q _{sync}	Total Gate Charge Sync. (Q _g - Q _{gd})		28.3			$I_D = 25A, V_{DS} = 0V, V_{GS} = 10V$
$t_{d(on)}$	Turn-On Delay Time		6.3		ns	$V_{DD} = 39V$
t _r	Rise Time		40			I _D = 25A
$t_{d(off)}$	Turn-Off Delay Time		49			$R_G = 20\Omega$
t _f	Fall Time		47			V _{GS} = 10V ④
C _{iss}	Input Capacitance		1150			$V_{GS} = 0V$
C _{oss}	Output Capacitance		130			$V_{DS} = 50V$
C _{rss}	Reverse Transfer Capacitance		67		pF	f = 1.0MHz
C _{oss} eff. (ER)	Effective Output Capacitance (Energy Related)®		190			V _{GS} = 0V, V _{DS} = 0V to 60V ©
C _{oss} eff. (TR)	Effective Output Capacitance (Time Related)®		230			V _{GS} = 0V, V _{DS} = 0V to 60V ⑤

Diode Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
I _S	Continuous Source Current			43	Α	MOSFET symbol
	(Body Diode)					showing the
I _{SM}	Pulsed Source Current			170		integral reverse
	(Body Diode) ①					p-n junction diode.
V_{SD}	Diode Forward Voltage			1.3	V	$T_J = 25^{\circ}C, I_S = 25A, V_{GS} = 0V \oplus$
t _{rr}	Reverse Recovery Time		22	33	ns	$T_J = 25$ °C $V_R = 51V$,
			26	39		$T_{J} = 125^{\circ}C$ $I_{F} = 25A$
Q _{rr}	Reverse Recovery Charge		17	26	nC	$T_J = 25^{\circ}C$ di/dt = 100A/µs @
			24	36		$T_J = 125^{\circ}C$
I _{RRM}	Reverse Recovery Current		1.4		Α	$T_J = 25^{\circ}C$
t _{on}	Forward Turn-On Time	Intrins	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)			

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Limited by T_{Jmax} , starting T_J = 25°C, L = 0.23mH R_G = 25 Ω , I_{AS} = 25A, V_{GS} =10V. Part not recommended for use above this value.
- $\label{eq:loss_def} \exists \ I_{SD} \leq 25A, \ di/dt \leq 1580A/\mu s, \ V_{DD} \leq V_{(BR)DSS}, \ T_J \leq 175^{\circ}C.$
- 4 Pulse width $\leq 400 \mu s$; duty cycle $\leq 2\%$.

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- $^{\circ}$ C_{oss} eff. (ER) is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS}.
- When mounted on 1" square PCB (FR-4 or G-10 Material). For recommended footprint and soldering techniques refer to application note #AN-994.
- $\ensuremath{\$}\xspace$ R_{θ} is measured at T_J approximately $90^{\circ}C.$

Qualification Information[†]

		Automotive			
			(per AEC-Q101) ^{††}		
Qualification	on Level	Comments: This part number(s) passed Automotive qualification IR's Industrial and Consumer qualification level is granted extension of the higher Automotive level.			
Moisture S	Sensitivity Level	D-PAK MSL1			
	Machine Model	Class M3 (+/- 250V) ^{†††}			
			AEC-Q101-002		
ECD	Human Body Model		Class H1A (+/- 500V) ^{†††}		
ESD		AEC-Q101-001			
	Charged Device	Class C5 (+/- 2000V) ^{†††}			
	Model	AEC-Q101-005			
RoHS Com	npliant		Yes		

[†] Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

^{††} Exceptions to AEC-Q101 requirements are noted in the qualification report.

^{†††} Highest passing voltage.

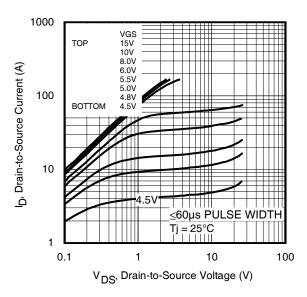


Fig 1. Typical Output Characteristics

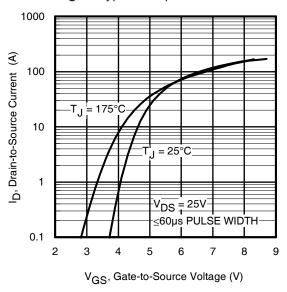


Fig 3. Typical Transfer Characteristics

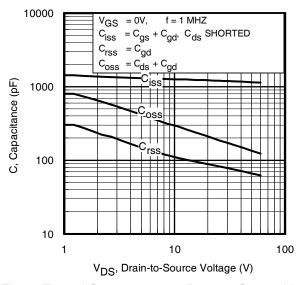


Fig 5. Typical Capacitance vs. Drain-to-Source Voltage

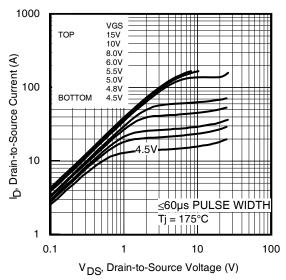


Fig 2. Typical Output Characteristics

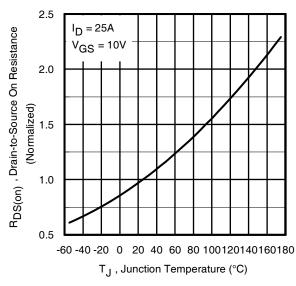


Fig 4. Normalized On-Resistance vs. Temperature

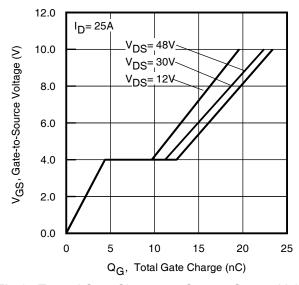


Fig 6. Typical Gate Charge vs. Gate-to-Source Voltage

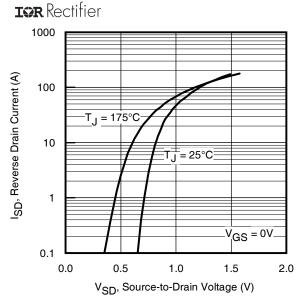


Fig 7. Typical Source-Drain Diode Forward Voltage

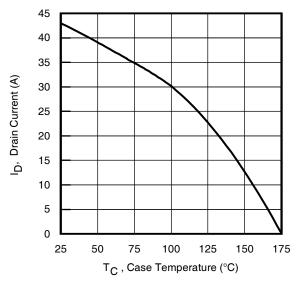


Fig 9. Maximum Drain Current vs. Case Temperature

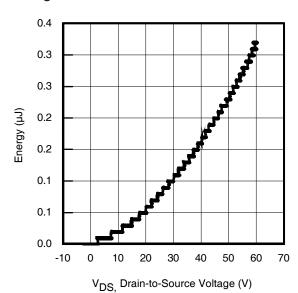


Fig 11. Typical C_{OSS} Stored Energy

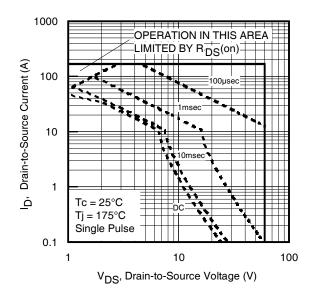


Fig 8. Maximum Safe Operating Area

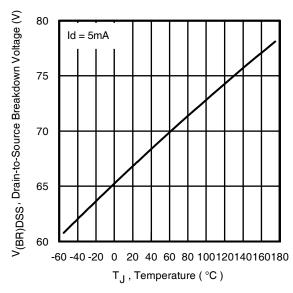


Fig 10. Drain-to-Source Breakdown Voltage

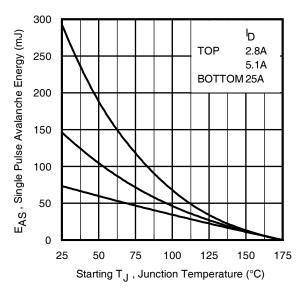


Fig 12. Maximum Avalanche Energy vs. DrainCurrent

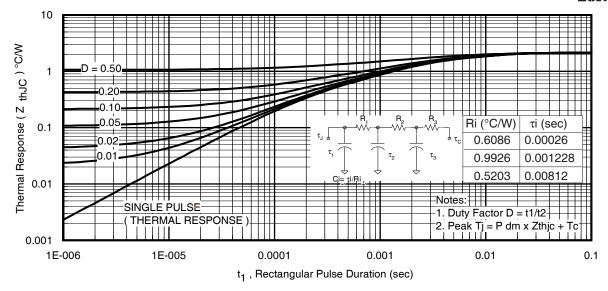


Fig 13. Maximum Effective Transient Thermal Impedance, Junction-to-Case

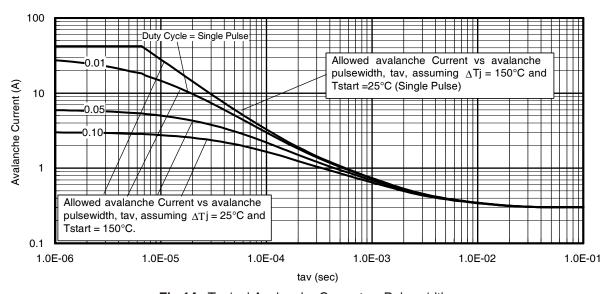


Fig 14. Typical Avalanche Current vs. Pulsewidth

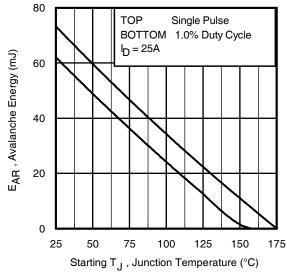


Fig 15. Maximum Avalanche Energy vs. Temperature

Notes on Repetitive Avalanche Curves , Figures 14, 15: (For further info, see AN-1005 at www.irf.com)

1. Avalanche failures assumption:

Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax} . This is validated for every part type.

- 2. Safe operation in Avalanche is allowed as long as T_{imax} is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 16a, 16b.
- 4. P_{D (ave)} = Average power dissipation per single avalanche pulse.
- 5. BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. I_{av} = Allowable avalanche current.
- 7. ΔT = Allowable rise in junction temperature, not to exceed T_{jmax} (assumed as 25°C in Figure 14, 15).

tav = Average time in avalanche.

D = Duty cycle in avalanche = $t_{av} \cdot f$

 $Z_{th,JC}(D, t_{av})$ = Transient thermal resistance, see Figures 13)

 $P_{D (ave)} = 1/2 (1.3 \cdot BV \cdot I_{av}) = \Delta T / Z_{thJC}$ $I_{av} = 2\Delta T / [1.3 \cdot BV \cdot Z_{th}]$ E_{AS (AR)} = P_{D (ave)}·t_{av}

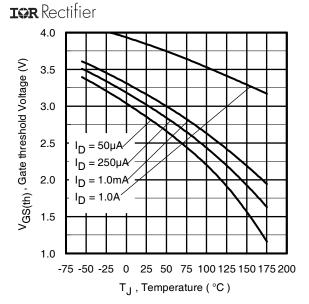


Fig 16. Threshold Voltage vs. Temperature

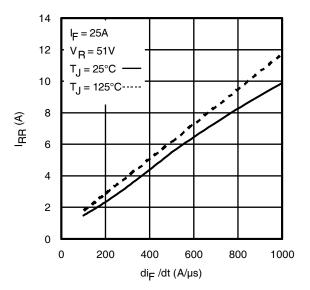


Fig. 18 - Typical Recovery Current vs. dif/dt

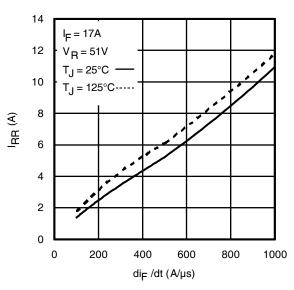


Fig. 17 - Typical Recovery Current vs. di_f/dt

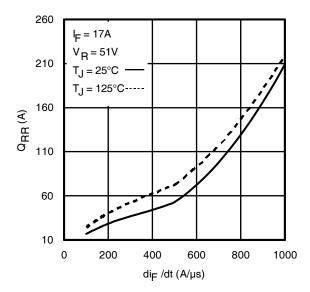


Fig. 19 - Typical Stored Charge vs. dif/dt

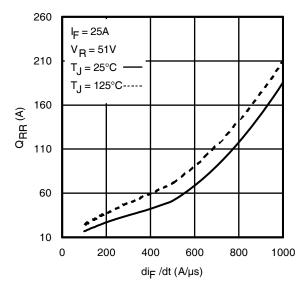


Fig. 20 - Typical Stored Charge vs. dif/dt

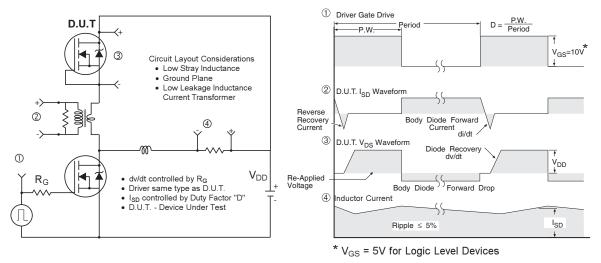


Fig 20. Peak Diode Recovery dv/dt Test Circuit for N-Channel HEXFET® Power MOSFETs

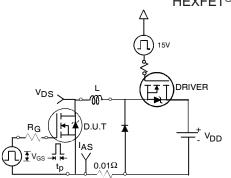


Fig 21a. Unclamped Inductive Test Circuit

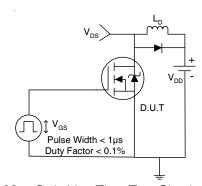


Fig 22a. Switching Time Test Circuit

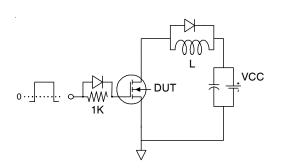


Fig 23a. Gate Charge Test Circuit

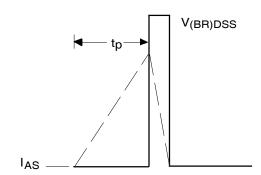


Fig 21b. Unclamped Inductive Waveforms

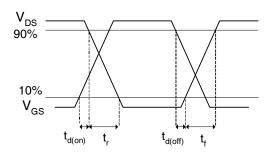


Fig 22b. Switching Time Waveforms

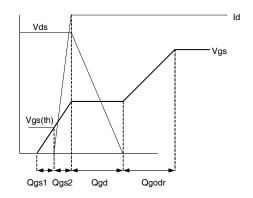
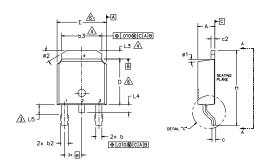


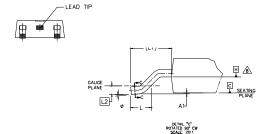
Fig 23b. Gate Charge Waveform

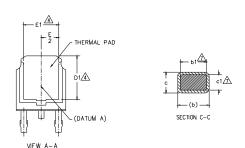


D-Pak (TO-252AA) Package Outline

Dimensions are shown in millimeters (inches)







NOTES:

- 1.- DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
- 2.- DIMENSION ARE SHOWN IN INCHES [MILLIMETERS].
- ⚠- LEAD DIMENSION UNCONTROLLED IN L5.
- 4- DIMENSION D1, E1, L3 & 63 ESTABLISH A MINIMUM MOUNTING SURFACE FOR THERMAL PAD.
- 5.- SECTION C-C DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN .005 AND 0.10 [0.13 AND 0.25] FROM THE LEAD TIP.
- DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005 [0,13] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
- ⚠- DIMENSION 61 & c1 APPLIED TO BASE METAL ONLY.
- A- DATUM A & B TO BE DETERMINED AT DATUM PLANE H
- 9.- OUTLINE CONFORMS TO JEDEC OUTLINE TO-252AA.

S Y M		N O T				
В	MILLIM	MILLIMETERS		INCHES		
0	MIN.	MAX.	MIN.	MAX.	E S	
Α	2.18	2.39	.086	.094		
A1	-	0.13	-	.005		
b	0.64	0.89	.025	.035		
ь1	0.65	0.79	.025	.031	7	
b2	0.76	1,14	.030	.045		
b3	4.95	5.46	.195	.215	4	
С	0.46	0.61	.018	.024		
c1	0.41	0.56	.016	.022	7	
c2	0,46	0.89	.018	.035		
D	5.97	6.22	.235	.245	6	
D1	5.21	-	.205	-	4	
E	6.35	6.73	.250	.265	6	
E1	4.32	-	.170	-	4	
e	2.29	2.29 BSC		BSC		
Н	9.40	10,41	.370	.410		
L	1.40	1.78	.055	.070		
L1	2.74	BSC	.108	REF.		
L2	0.51	BSC	.020	.020 BSC		
L3	0.89	1.27	.035	.050	4	
L4	-	1.02	-	.040		
L5	1.14	1.52	.045	.060	3	
Ø	0,	10*	0,	10*		
ø1	0,	15*	0,	15*		
ø2	25*	35*	25*	35*		

LEAD ASSIGNMENTS

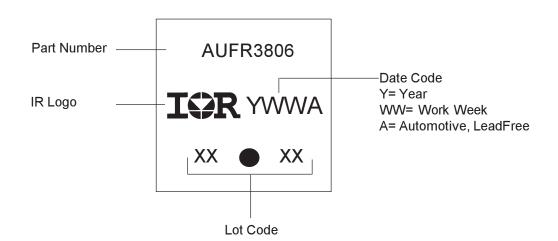
HEXFET

- 2.- DRAIN
- 3.- SOURCE 4.- DRAIN

IGBT & CoPAK

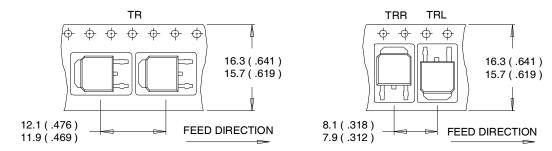
- 1.- GATE
- 2.- COLLECTOR 3.- EMITTER
- 4.- COLLECTOR

D-Pak Part Marking Information



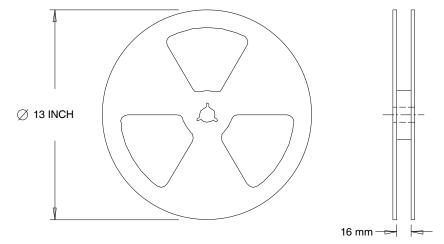
D-Pak (TO-252AA) Tape & Reel Information

Dimensions are shown in millimeters (inches)



NOTES:

- 1. CONTROLLING DIMENSION : MILLIMETER.
- 2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
- 3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES:

1. OUTLINE CONFORMS TO EIA-481.

Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

Ordering Information

Base part number	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRFR3806	Dpak	Tube	75	AUIRFR3806
		Tape and Reel	2000	AUIRFR3806TR
		Tape and Reel Left	3000	AUIRFR3806TRL
		Tape and Reel Right	3000	AUIRFR3806TRR

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IR products are neither designed nor intended for use in automotive applications or environments unless the specific IR products are designated by IR as compliant with ISO/TS 16949 requirements and bear a part number including the designation "AU". Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, IR will not be responsible for any failure to meet such requirements.

For technical support, please contact IR's Technical Assistance Center http://www.irf.com/technical-info/

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Authorized Distribution Brand:

























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